

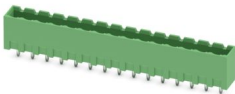
MSTBVA 2,5/15-G - PCB header

1755639

<https://www.phoenixcontact.com/us/products/1755639>



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PCB headers, nominal cross section: 2.5 mm², color: green, nominal current: 12 A, rated voltage (III/2): 320 V, contact surface: Sn, contact connection type: Pin, number of potentials: 15, number of rows: 1, number of positions: 15, number of connections: 15, product range: MSTBVA 2,5/..-G, pitch: 5 mm, mounting: Wave soldering, pin layout: Linear pinning, solder pin [P]: 3.9 mm, number of solder pins per potential: 1, plug-in system: COMBICON MSTB 2,5, Pin connector pattern alignment: Standard, locking: without, mounting method: without, type of packaging: packed in cardboard

Your advantages

- Standard pin strip for 320 V (III/2)

Commercial data

Item number	1755639
Packing unit	50 pc
Minimum order quantity	50 pc
Sales key	AA03
Product key	AACSLE
GTIN	4017918029210
Weight per piece (including packing)	6.47 g
Weight per piece (excluding packing)	5.65 g
Customs tariff number	85366930
Country of origin	DE

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Technical data

Product properties

Product type	PCB headers
Product family	MSTBVA 2,5/..-G
Product line	COMBICON Connectors M
Type	Standard
Number of positions	15
Pitch	5 mm
Number of connections	15
Number of rows	1
Number of potentials	15
Mounting type	without
Pin layout	Linear pinning
Solder pins per potential	1

Electrical properties

Properties

Nominal current I_N	12 A
Nominal voltage U_N	320 V
Contact resistance	2.5 mΩ
Rated voltage (III/3)	250 V
Rated surge voltage (III/3)	4 kV
Rated voltage (III/2)	320 V
Rated surge voltage (III/2)	4 kV
Rated voltage (II/2)	400 V
Rated surge voltage (II/2)	4 kV

Mounting

Mounting type	Wave soldering
Pin layout	Linear pinning

Material specifications

Material data - contact

Note	WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/JEDEC JESD 201
Contact material	Cu alloy
Surface characteristics	Tin-plated
Metal surface contact area (top layer)	Tin (3 - 5 μm Sn)
Metal surface contact area (middle layer)	Nickel (1.3 - 3 μm Ni)
Metal surface soldering area (top layer)	Tin (3 - 5 μm Sn)
Metal surface soldering area (middle layer)	Nickel (1.3 - 3 μm Ni)

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Material data - housing

Color (Housing)	green (6021)
Insulating material	PBT
Insulating material group	IIIa
CTI according to IEC 60112	225
Flammability rating according to UL 94	V0

Notes

Notes on operation	In accordance with IEC 61984, COMBICON connectors have no switching power (COC). During designated use, they must not be plugged in or disconnected when carrying voltage or under load.
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Dimensions

Dimensional drawing	
Pitch	5 mm
Width [w]	77 mm
Height [h]	15.9 mm
Length [l]	8.57 mm
Installed height	12 mm
Solder pin length [P]	3.9 mm
Pin dimensions	1 x 1 mm

PCB design

Hole diameter	1.4 mm
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Mechanical tests

Visual inspection

Specification	IEC 60512-1-1:2002-02
Result	Test passed

Dimension check

Specification	IEC 60512-1-2:2002-02
Result	Test passed

Resistance of inscriptions

Specification	IEC 60068-2-70:1995-12
Result	Test passed

Polarization and coding

Specification	IEC 60512-13-5:2006-02
Result	Test passed

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Contact holder in insert

Specification	IEC 60512-15-1:2008-05
Contact holder in insert Requirements >20 N	Test passed

Insertion and withdrawal forces

Result	Test passed
No. of cycles	25
Insertion strength per pos. approx.	8 N
Withdraw strength per pos. approx.	6 N

Electrical tests

Thermal test | Test group C

Specification	IEC 60512-5-1:2002-02
Tested number of positions	24

Insulation resistance

Specification	IEC 60512-3-1:2002-02
Insulation resistance, neighboring positions	> 5 MΩ

Air clearances and creepage distances |

Specification	IEC 60664-1:2007-04
Insulating material group	IIIa
Comparative tracking index (IEC 60112)	CTI 225
Rated insulation voltage (III/3)	250 V
Rated surge voltage (III/3)	4 kV
minimum clearance value - non-homogenous field (III/3)	3 mm
minimum creepage distance (III/3)	4 mm
Rated insulation voltage (III/2)	320 V
Rated surge voltage (III/2)	4 kV
minimum clearance value - non-homogenous field (III/2)	3 mm
minimum creepage distance (III/2)	3.2 mm
Rated insulation voltage (II/2)	400 V
Rated surge voltage (II/2)	4 kV
minimum clearance value - non-homogenous field (II/2)	3 mm
minimum creepage distance (II/2)	4 mm

Environmental and real-life conditions

Vibration test

Specification	IEC 60068-2-6:2007-12
Frequency	10 - 150 - 10 Hz
Sweep speed	1 octave/min
Amplitude	0.35 mm (10 Hz ... 60.1 Hz)
Acceleration	5g (60.1 Hz ... 150 Hz)

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Test duration per axis	2.5 h
Test directions	X-, Y- and Z-axis

Durability test

Specification	IEC 60512-9-1:2010-03
Impulse withstand voltage at sea level	4.8 kV
Contact resistance R ₁	2.5 mΩ
Contact resistance R ₂	2.5 mΩ
Insertion/withdrawal cycles	25
Insulation resistance, neighboring positions	> 5 MΩ

Climatic test

Specification	ISO 6988:1985-02
Corrosive stress	0.2 dm ³ SO ₂ on 300 dm ³ /40 °C/1 cycle
Thermal stress	100 °C/168 h
Power-frequency withstand voltage	2.21 kV

Ambient conditions

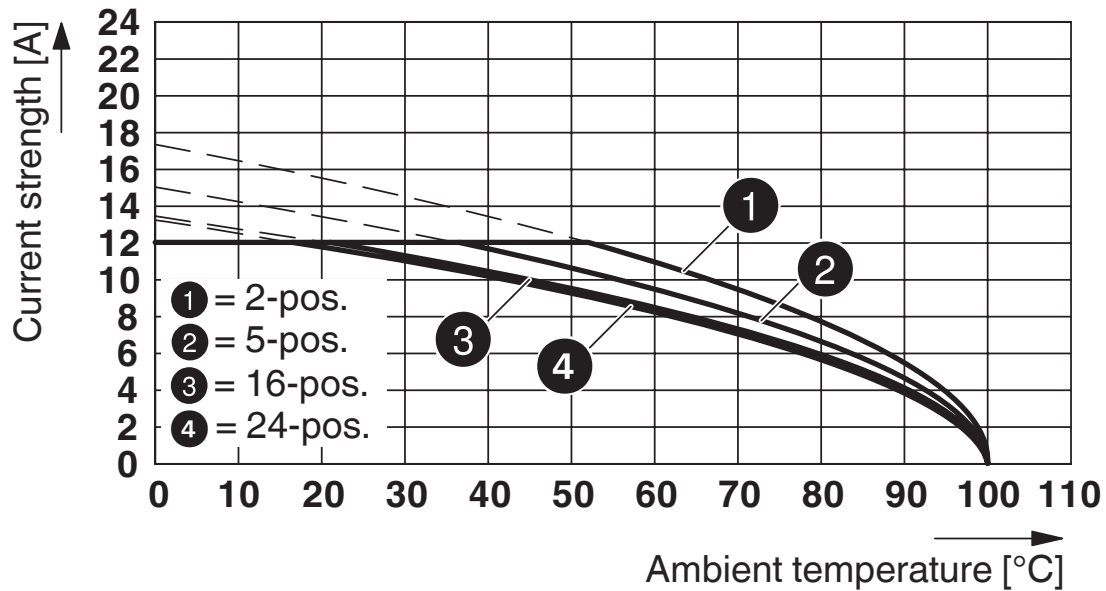
Ambient temperature (operation)	-40 °C ... 100 °C (dependent on the derating curve)
Ambient temperature (storage/transport)	-40 °C ... 70 °C
Relative humidity (storage/transport)	30 % ... 70 %
Ambient temperature (assembly)	-5 °C ... 100 °C

Packaging specifications

Type of packaging	packed in cardboard
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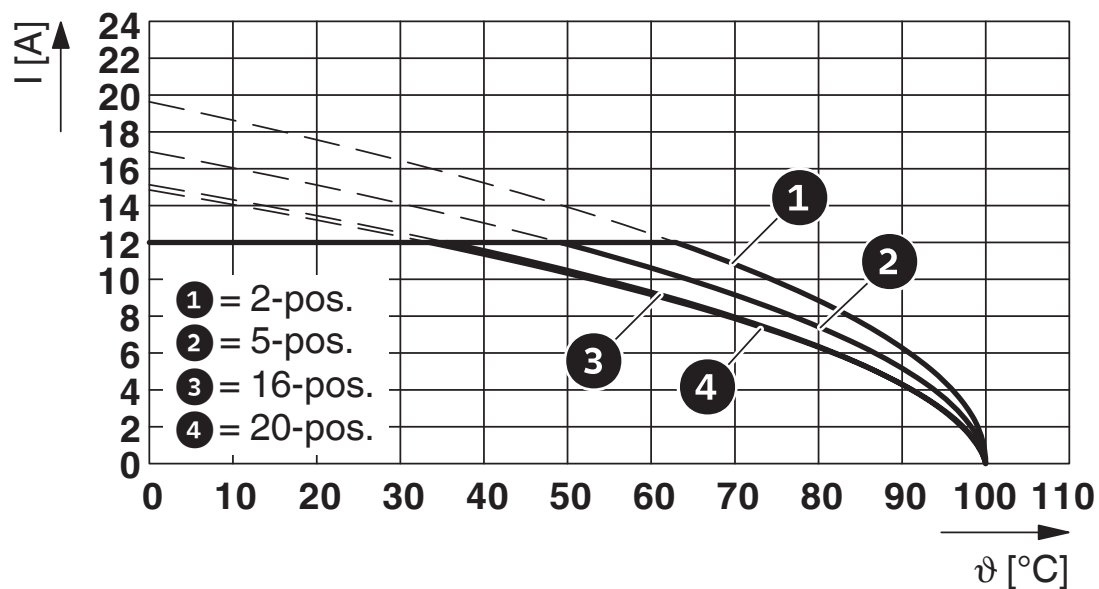
Drawings

Diagram

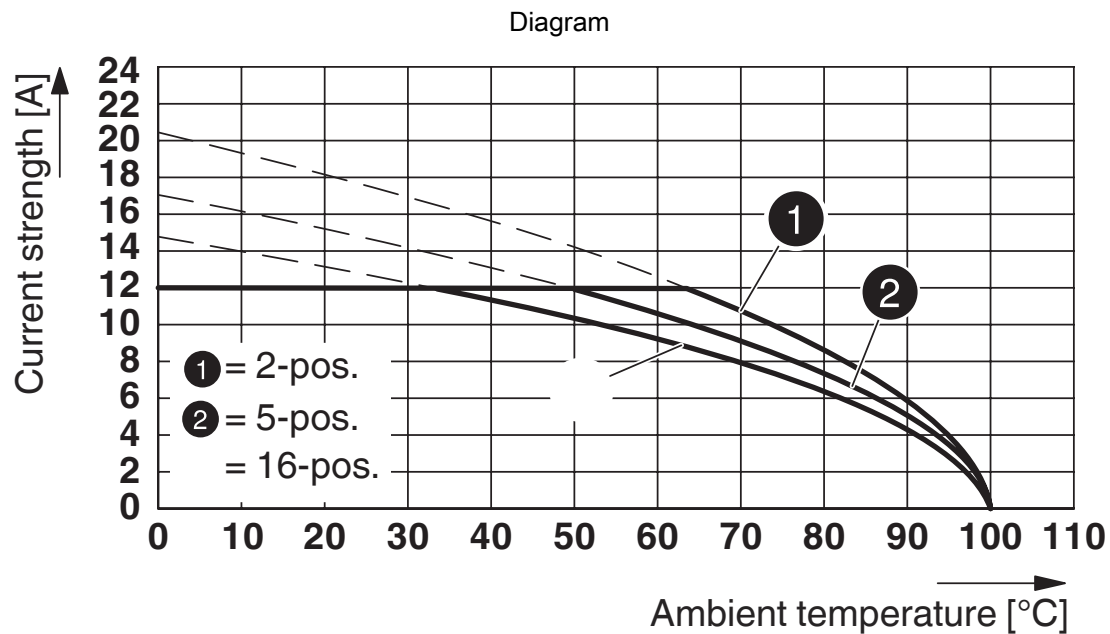


Type: MSTB 2,5/...-ST with MSTBVA 2,5/...-G

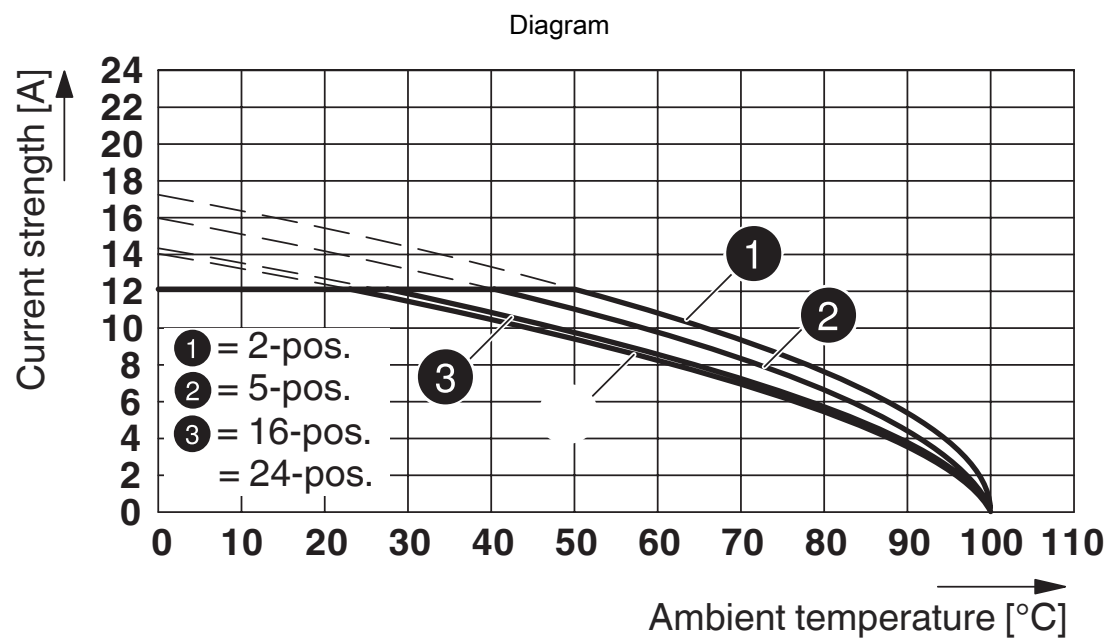
Diagram



Type: FKCT 2,5/...-ST with MSTBVA 2,5/...-G



Type: MSTBT 2,5/...-ST with MSTBVA 2,5/...-G



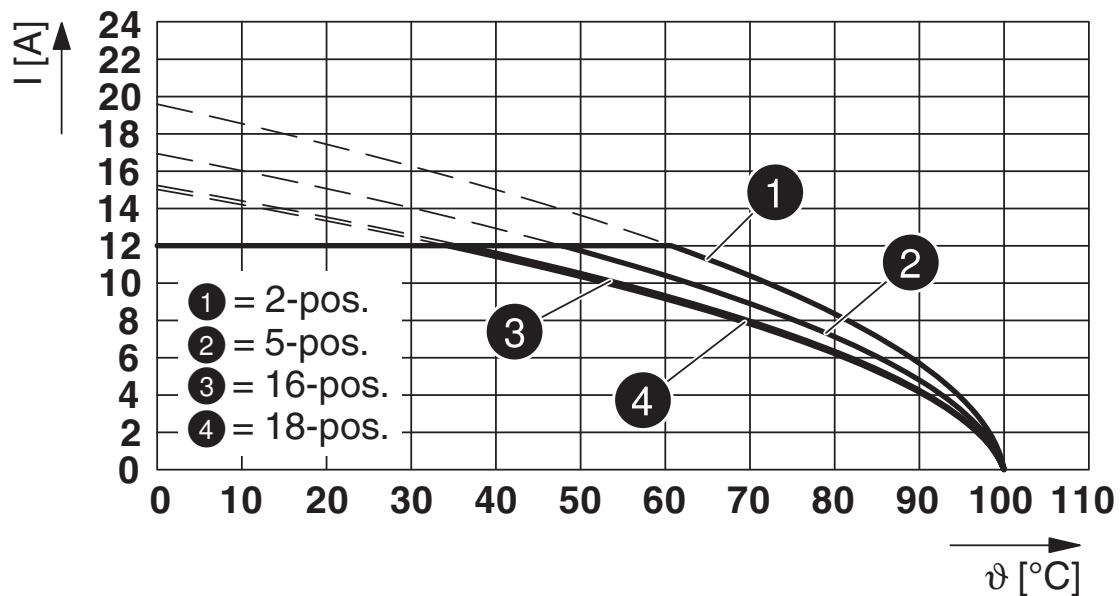
Type: MSTBP 2,5/...-ST with MSTBVA 2,5/...-G

Diagram

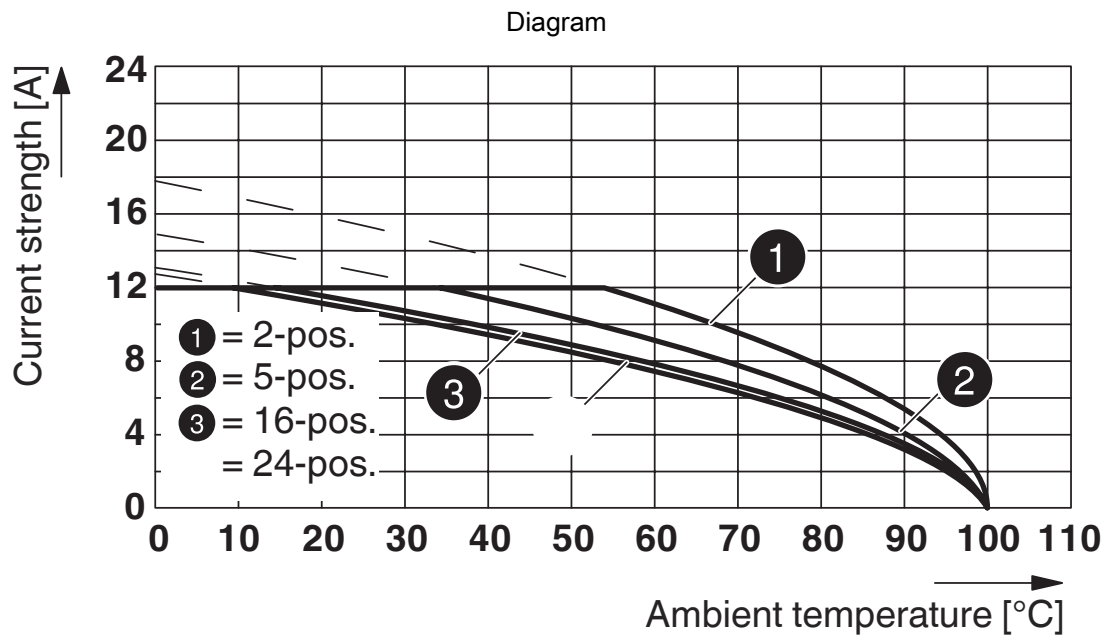


Type: FKCN 2,5/...-ST with MSTBVA 2,5/...-G

Diagram



Type: FKCV(W/R) 2,5/...-ST with MSTBVA 2,5/...-G



Type: SMSTB 2,5/...-ST with MSTBVA 2,5/...-G



Type: MVSTBR 2,5/...-ST with MSTBVA 2,5/...-G

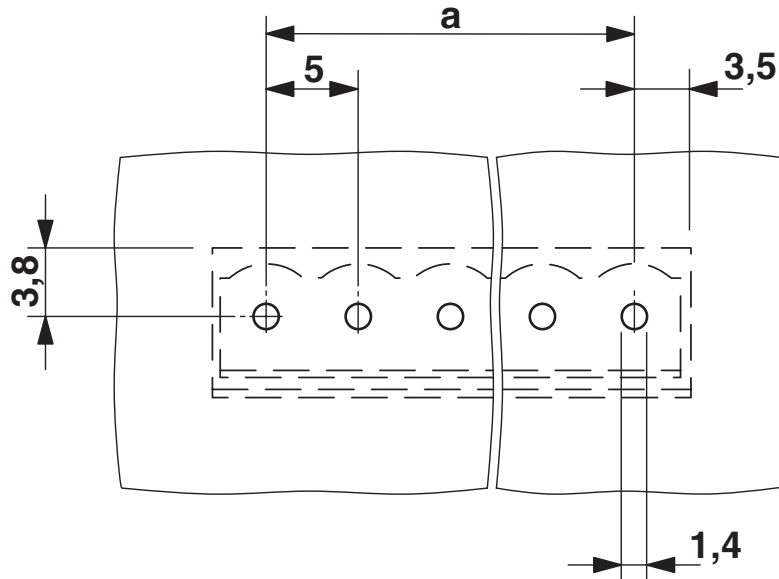
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Drilling plan/solder pad geometry



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Approvals

To download certificates, visit the product detail page: <https://www.phoenixcontact.com/us/products/1755639>

 CSA Approval ID: 13631-2585951				
	Nominal voltage U_N	Nominal current I_N	Cross section AWG	Cross section mm^2
B				
	300 V	12 A	-	-
D				
	300 V	10 A	-	-

 cULus Recognized Approval ID: E60425-19931011				
	Nominal voltage U_N	Nominal current I_N	Cross section AWG	Cross section mm^2
B				
	300 V	12 A	-	-
D				
	300 V	10 A	-	-

 VDE approval of drawings Approval ID: 40050648				
	Nominal voltage U_N	Nominal current I_N	Cross section AWG	Cross section mm^2
keine				
	250 V	12 A	-	-

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Classifications

ECLASS

ECLASS-13.0	27460201
ECLASS-15.0	27460201

ETIM

ETIM 9.0	EC002637
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UNSPSC

UNSPSC 21.0	39121400
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Environmental product compliance

EU RoHS	
Fulfills EU RoHS substance requirements	Yes, No exemptions
China RoHS	
Environment friendly use period (EFUP)	EFUP-E
	No hazardous substances above the limits
EU REACH SVHC	
REACH candidate substance (CAS No.)	No substance above 0.1 wt%

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